


	#	Layer	Thickness	Description	Dk	Df	Note
		Top Solder	0.015mm	Soldermask IPC-SM840	3,5	0,028	used on rigid parts
	1	Top Side	0.035mm	Starting foil 1/2oz. after plating and processing			
			0.125mm	Prepreg IPC-4101/21	3,5	0,02	FR-4.0
	2	Inner Layer 1	0.035mm	ED Base Copper			
			0.710mm	Core IPC-4101/21	4,7	0,02	FR-4.0
	3	Inner Layer 2	0.035mm	ED Base Copper			
			0.125mm	Prepreg IPC-4101/21	3,5	0,02	FR-4.0
	4	Inner Layer 3	0.035mm	ED Base Copper			
			0.710mm	Core IPC-4101/21	4,7	0,02	FR-4.0
	5	Inner Layer 4	0.035mm	ED Base Copper			
			0.125mm	Prepreg IPC-4101/21	3,5	0,02	FR-4.0
	6	Bottom Side	0.035mm	Starting foil 1/2oz. after plating and processing			
		Bottom Solder	0.015mm	Soldermask IPC-SM840	3,5	0,028	used on rigid parts
Total thickness: 2.035mm							

	BASIC6_ML6_2,04_35_V2.12				
notes:	PCB Thickness Tolerance: ± 10%				
	customer		created		
Final copper thickness according to IPC-6012	pcb name		approved		
	engineer		format	A4, landscape	
Please regard to our sectional design rules: ► www.we-online.com	date				
	Template Revision: 02/2021 by Andreas Schilpp / Michael Kress / Werner Öchslen				